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Patent
259/079
P01-0015

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

KENNY, Michael et al.

Serial No.: 09/925,884

Filed: August 6, 2001

For: **Process And Apparatus For Treating A
Workpiece Such As A Semiconductor Wafer**

) Group Art Unit: 1746
)
) Examiner: Not yet assigned
)
)
)
)
)
)

SUPPLEMENTAL RESPONSE TO NOTICE TO FILE

CORRECTED APPLICATION PAPERS

Commissioner for Patents
Washington, D.C. 20231

Sir:

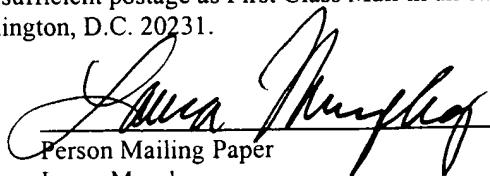
1. A Notice to File Corrected Application Papers was mailed on October 1, 2001 (copy enclosed as Exhibit 1).

2. In response, on November 16, 2001, Applicant mailed in Formal Drawings, to overcome the objections to the drawings filed with the Application, under 37 CFR 1.84(e). A copy of the 10/01/01 Notice was not included with the drawings mailed in on November 16, 2001.

CERTIFICATE OF MAILING
(37 C.F.R. §1.8a)

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as First Class Mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

March 8 2002
Date of Deposit


Person Mailing Paper
Laura Murphy

3. The PAIR Information for this Application as of March 6, 2002 shows no receipt of Applicant's November 16, 2001 Submittal. Accordingly, Applicant resubmits herewith a copy of the filing made November 16, 2001 (attached as Exhibit 2), as a conditional response in the event that the drawings filed November 16, 2001 were not considered responsive to the October 1, 2001 Notice.

4. As Applicant submits that the November 16, 2001 filing was fully responsive to the 10/01/2001 Notice, Applicant believes no fees are due under 37 CFR 1.136. However, if the Director determines otherwise, then fees under 37 CFR 1.136 may be charged to Deposit Account No. 12-2475, if necessary to avoid abandonment.

Respectfully submitted,

LYON & LYON LLP

Dated: March 7, 2002

By: Kenneth H. Ohriner
Kenneth H. Ohriner
Reg. No. 31,646

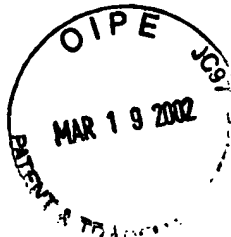
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COPY PAPERS
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UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS
UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231
www.uspto.gov

APPLICATION NUMBER	FILING/RECEIPT DATE	FIRST NAMED APPLICANT	ATTORNEY DOCKET NUMBER
09/925,884	08/06/2001	Michael Kenny	259/079

22249
LYON & LYON LLP
633 WEST FIFTH STREET
SUITE 4700
LOS ANGELES, CA 90071

CONFIRMATION NO. 7035

FORMALITIES LETTER



OC000000006816671

Date Mailed: 10/01/2001

NOTICE TO FILE CORRECTED APPLICATION PAPERS

Filing Date Granted

This application has been accorded an Application Number and Filing Date. The application, however, is informal since it does not comply with the regulations for the reason(s) indicated below. Applicant is given **TWO MONTHS** from the date of this Notice within which to correct the informalities indicated below. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a)

The required item(s) identified below must be timely submitted to avoid abandonment:

- Substitute drawings in compliance with 37 CFR 1.84 because:
 - drawings submitted to the Office are not electronically reproducible. Drawing sheets must be submitted on paper which is flexible, strong, white, smooth, non-shiny, and durable (see 37 CFR 1.84(e));

*A copy of this notice **MUST** be returned with the reply.*

B/S

Customer Service Center

Initial Patent Examination Division (703) 308-1202

PART 2 - COPY TO BE RETURNED WITH RESPONSE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

KENNY, Michael et al.

Serial No.: 09/925,884

Filed: August 6, 2001

For: Process And Apparatus For Treating
A Workpiece Such As A Semiconductor
Wafer



Group Art Unit: 1746

Examiner: Not yet assigned

TRANSMITTAL OF FORMAL DRAWINGS

Commissioner for Patents
Washington, D.C. 20231

Sir:

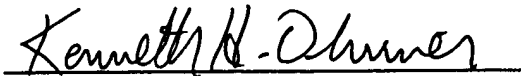
Transmitted herewith for filing in the above-referenced application are formal drawings

(11 sheets).

Respectfully submitted,
LYON & LYON LLP

Dated: November 15, 2001

By:


Kenneth H. Ohriner
Reg. No. 31,646



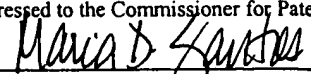
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CERTIFICATE OF MAILING
(37 C.F.R. §1.8a)

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as First Class Mail in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

November 16, 2001
Date of Deposit
LA-217638.1


Signature of Person Mailing Paper
Maria D. Santos



COPY OF PAPERS
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Please acknowledge receipt of the following by affixing hereon the Patent and Trademark Office date stamp and returning this card to our office.

Applicant: KENNY, Michael et al.
For: PROCESS AND APPARATUS FOR TREATING A WORKPIECE
SUCH AS A SEMICONDUCTOR WAFER

FILING OF FORMAL DRAWINGS

Attorney(s): Kenneth H. Ohriner
Docket No.: 259/079 P01-0015
Date of Deposit: November 16, 2001
Enclosure(s): Formal Drawing Transmittal; Formal Drawings (11 sheets) and Postcard

